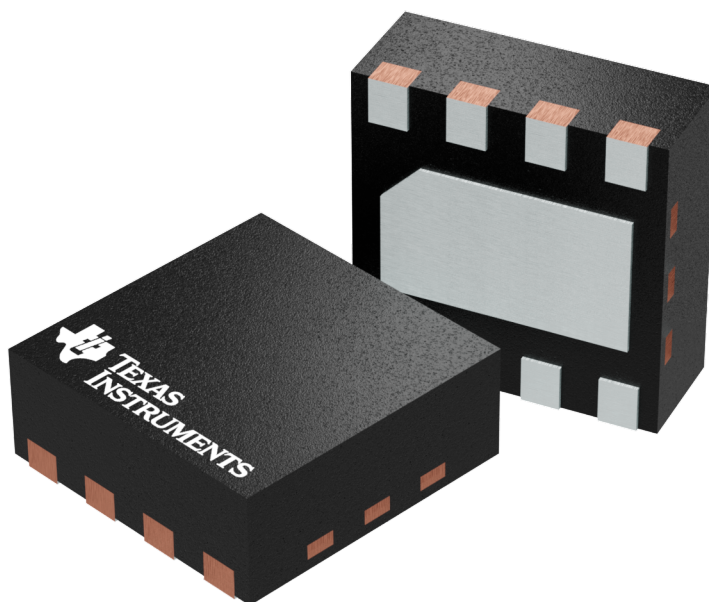




Images above are just a representation of the package family, actual package may vary.
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